

Figure 3.1. Moisture gradients measured on five different days by the Bandsaw slicing technique.

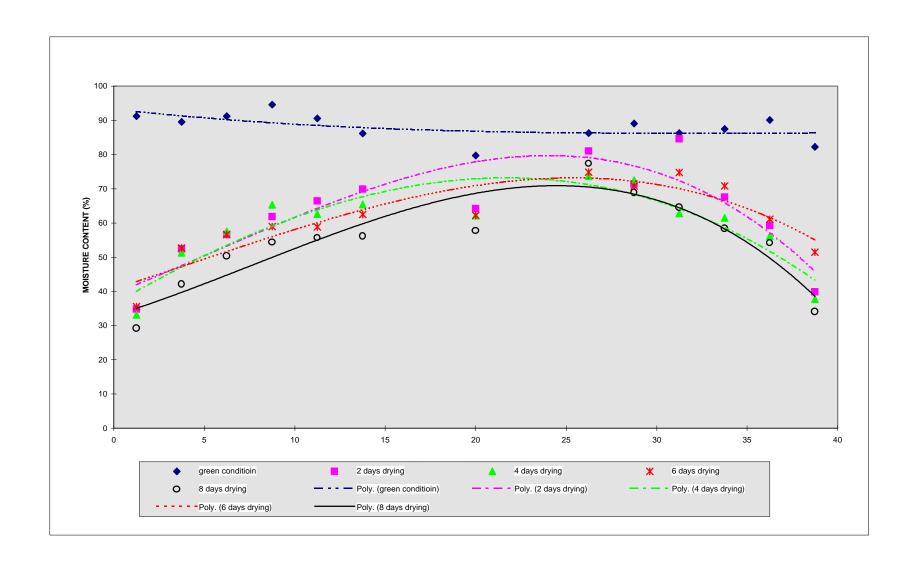


Figure 3.2. Moisture gradients measured on five different days by the Forstner bit layering technique

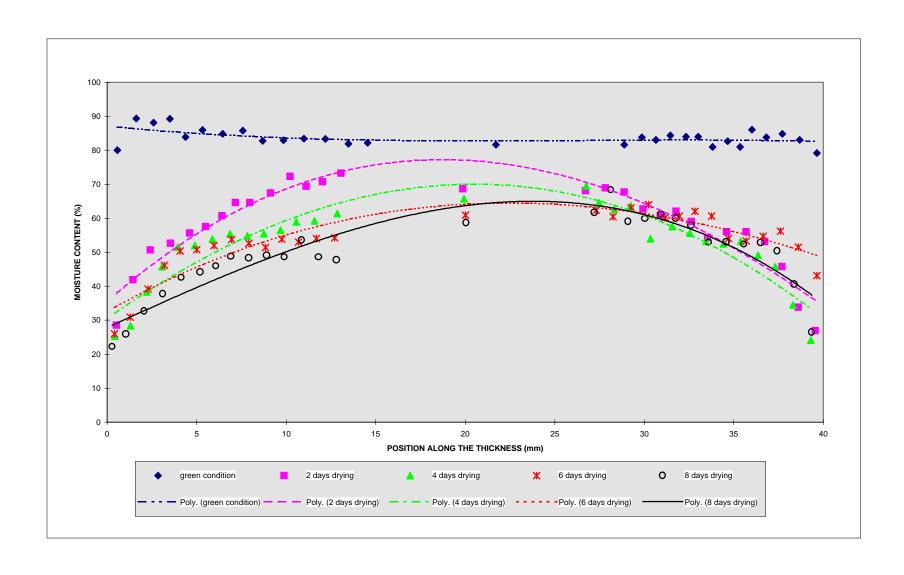


Figure 3.3. Moisture gradients measured on five different days by the Flakering technique

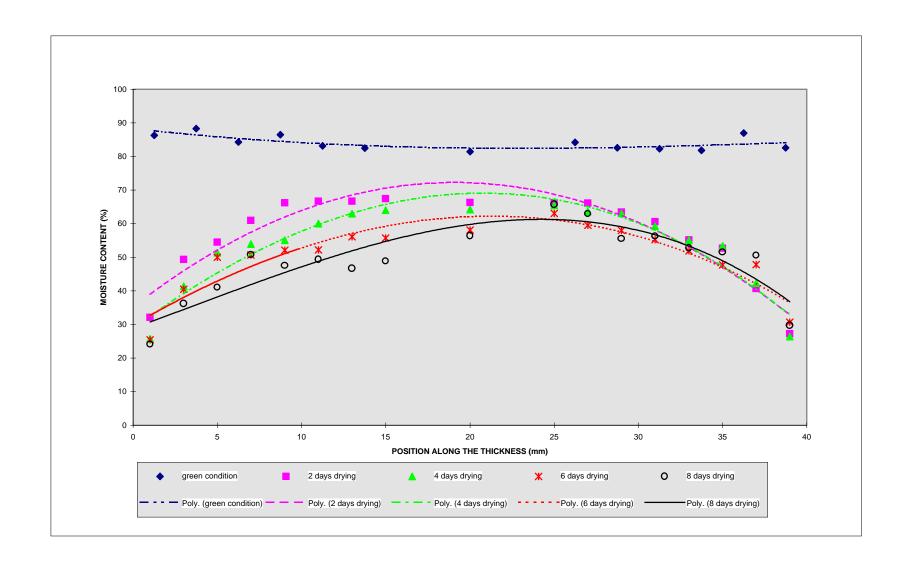


Figure 3.4. Moisture gradients measured on five different days by the Razor blade slicing technique

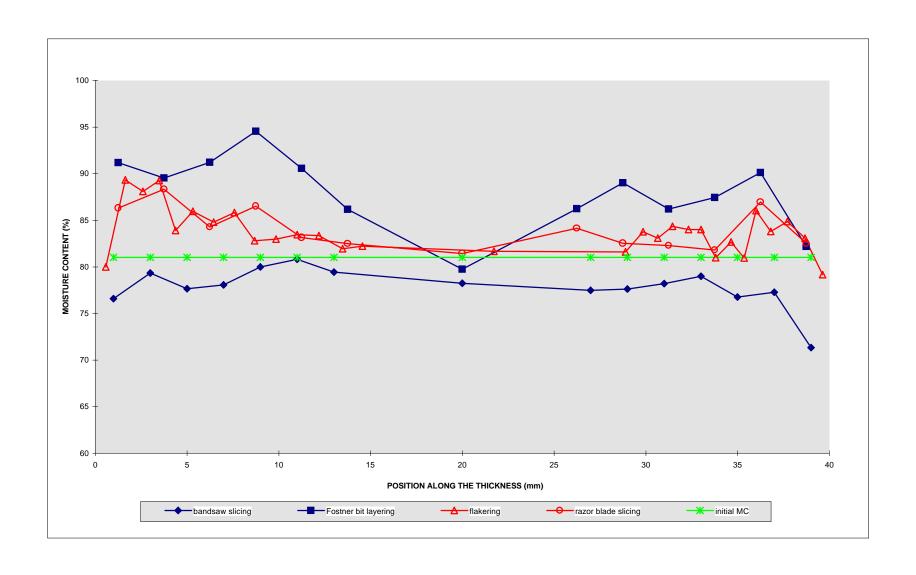


Figure 3.5. Moisture gradients measured by the four techniques under the green condition

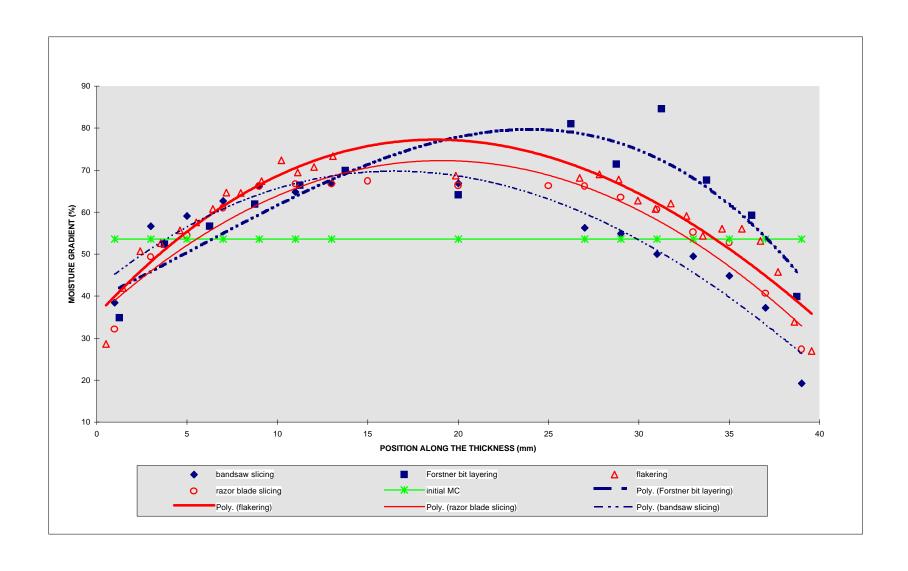


Figure 3.6. Moisture gradients measured by the four techniques after 2 days kiln drying

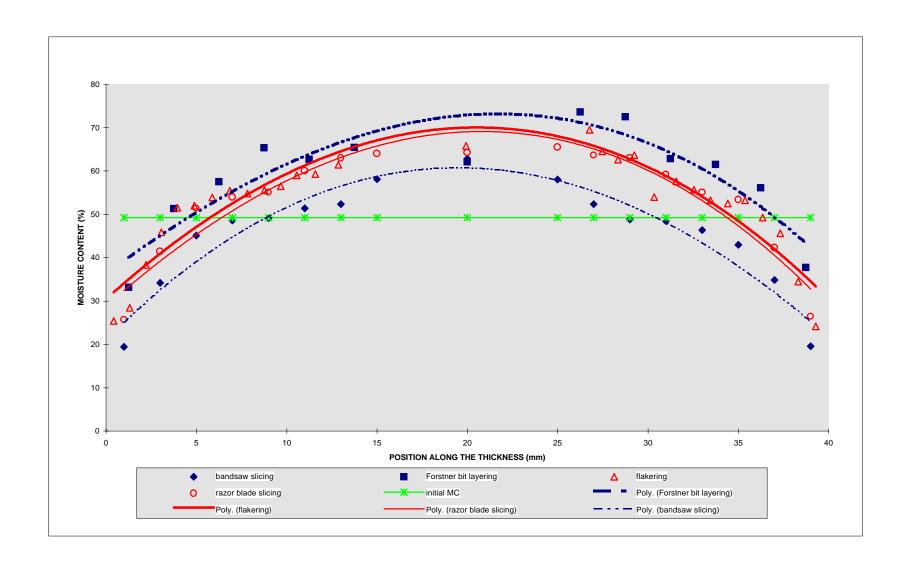


Figure 3.7. Moisture gradients measured by the four techniques after 4 days kiln drying

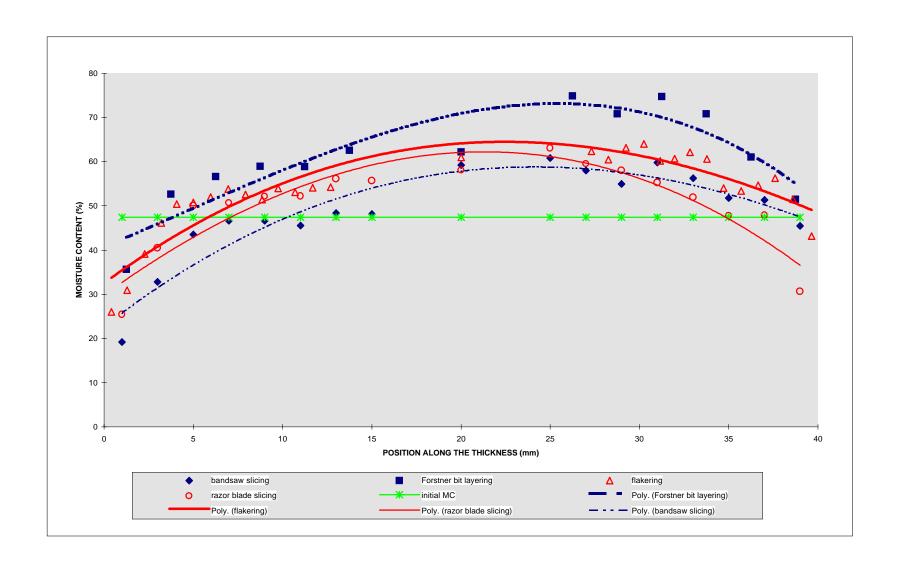


Figure 3.8. Moisture gradients measured by the four techniques after 6 days kiln drying

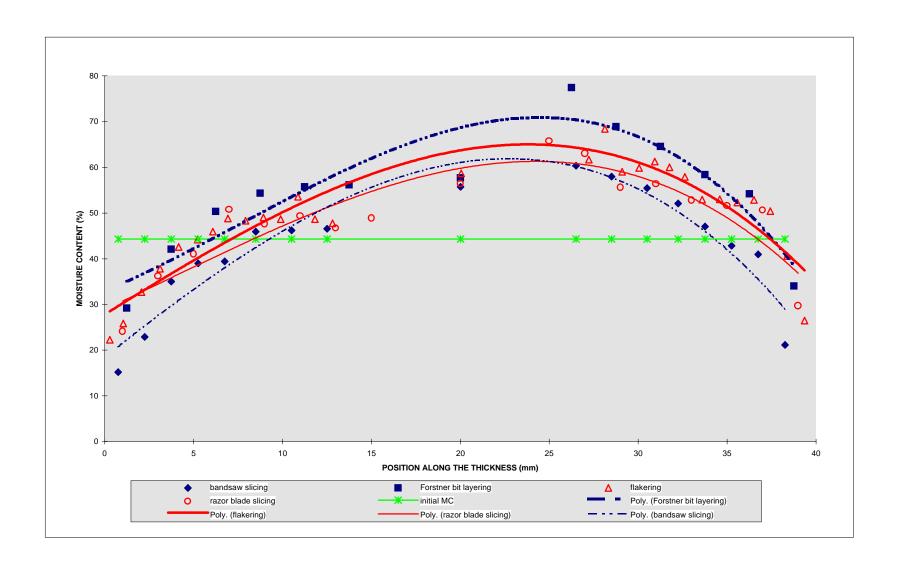


Figure 3.9. Moisture gradients measured by the four techniques after 8 days kiln drying